AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the application:

LISTING OF CLAIMS:

- 1. (currently amended): A resin<u>ous multilayer structure-substrate</u> for optical use which comprises a <u>resinous</u> multilayer structure having a surface roughness, R_a , of 0.8 nm or lower on at least one side and having an average thickness of from 100 to 800 μ m.
- 2. (currently amended): The resinous multilayer structure substrate for optical use of claim 1, wherein the <u>resinous</u> multilayer structure comprises a layer of a cured epoxy resin as a base layer.
- 3. (currently amended): The resinous multilayer structure substrate for optical use of claim 2, wherein the resinous multilayer structure further comprises a transparent hard coat layer having a thickness of 0.1 μ m or larger as a surface layer and a poly(vinyl alcohol)-based gas barrier layer as an intermediate layer between the hard coat layer and the base layer.
- 4. (currently amended): The resin<u>ous multilayer structure</u> substrate for optical use of claim 1, wherein the surface roughness Ra is 0.2 nm or lower.

AMENDMENT UNDER 37 C.F.R. § 1.116

U.S. Application No. 09/769,376

Q62053

- 5. (currently amended): The resin<u>ous multilayer structure</u> substrate for optical use of claim 1, wherein the average thickness is from 200 to 500 μm.
- 6. (currently amended): The resin<u>ous multilayer structure</u> substrate for optical use of claim 2, wherein the epoxy resin is selected from the group consisting of a bisphenol A type epoxy resin, an alicyclic type epoxy resin, and a tryglycidyl isocyanurate type epoxy resin.